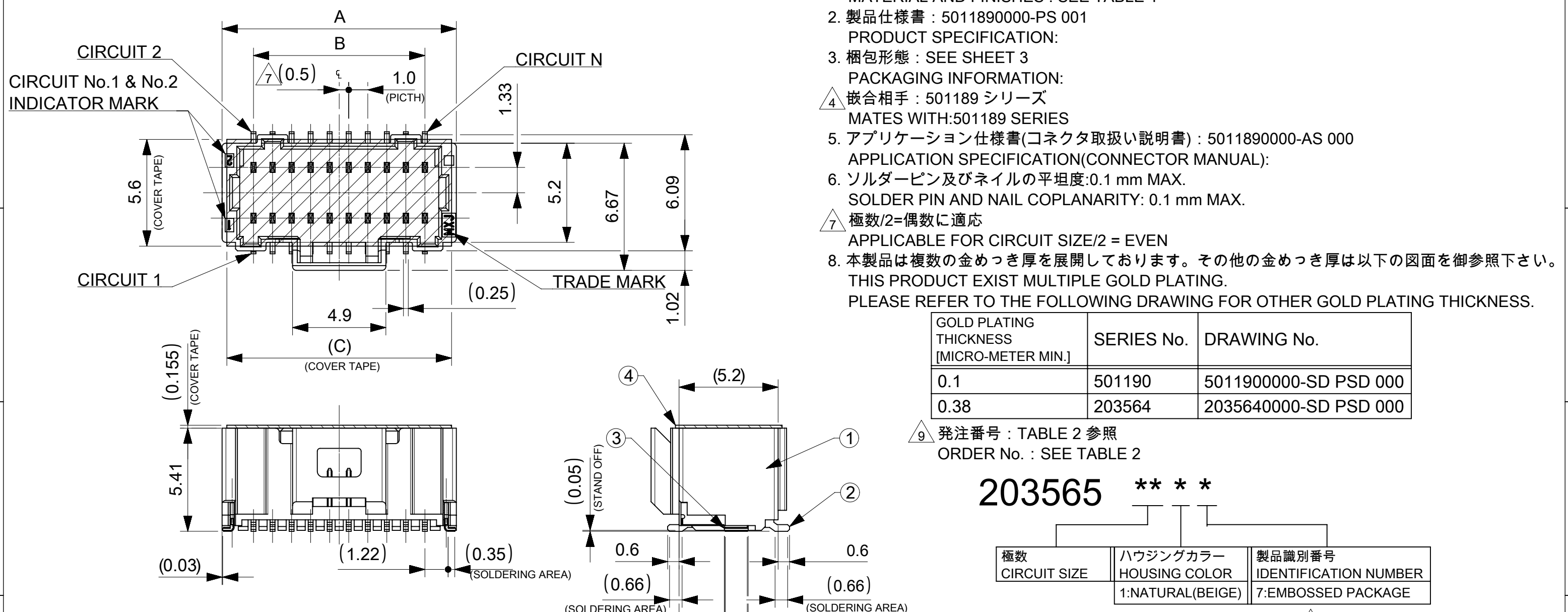




1

TABLE 1

番号 NO.	部品 PART	材質 MATERIAL
①	ウエハー WAFER	ポリアミド(PA), UL94V-0, 色 : SEE SHEET 5 POLYAMIDE(PA), UL94V-0, COLOR : SEE SHEET 5
②	ソルダープイン SOLDER PIN	リン青銅 PHOSPHOR BRONZE
		接点部 CONTACT AREA
		テール部 TAIL AREA
③	ネイル NAIL	下地めっき UNDER PLATING
		ニッケルめっき : 1.27 MICRO-METER MIN. NICKEL
		リン青銅 PHOSPHOR BRONZE
④	カバーテープ COVER TAPE	テール部 TAIL AREA
		下地めっき UNDER PLATING
		ニッケルめっき : 1.0 MICRO-METER MIN. NICKEL
④	ポリイミドテープ POLYIMIDE TAPE	金めっき : 0.76 MICRO-METER MIN. GOLD PLATING
		金めっき GOLD PLATING
		ニッケルめっき : 1.0 MICRO-METER MIN. NICKEL

9

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26.8

21.8

16.8

11.8

C

極数別 寸法
DIMENSION

8

24.0

19.0

14.0

9.0

B

極数
CIRCUIT SIZE

7

27.3

22.3

17.3

12.3

A

発注番号 ORDER No.

7

203565 5017

203565 4017

203565 3017

203565 2017

発注番号 ORDER No.

6

50

40

30

20

極数
CIRCUIT SIZE

6

203565 5017

203565 4017

203565 3017

203565 2017

発注番号 ORDER No.

5

50

40

30

20

極数
CIRCUIT SIZE

5

203565 5017

203565 4017

203565 3017

203565 2017

発注番号 ORDER No.

4

50

40

30

20

極数
CIRCUIT SIZE

4

203565 5017

203565 4017

203565 3017

203565 2017

発注番号 ORDER No.

3

50

40

30

20

極数
CIRCUIT SIZE

3

203565 5017

203565 4017

203565 3017

203565 2017

発注番号 ORDER No.

2

50

40

30

20

極数
CIRCUIT SIZE

2

203565 5017

203565 4017

203565 3017

203565 2017

発注番号 ORDER No.

1

50

40

30

20

極数
CIRCUIT SIZE

1

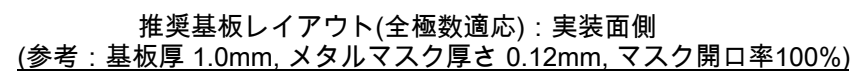
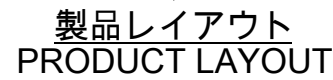
203565 5017

203565 4017

203565 3017

203565 2017

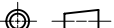
発注番号 ORDER No.

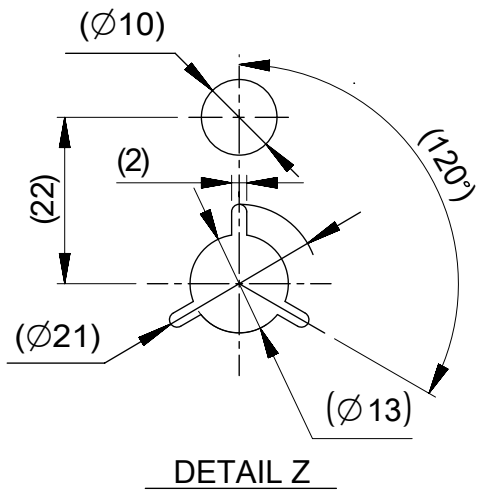
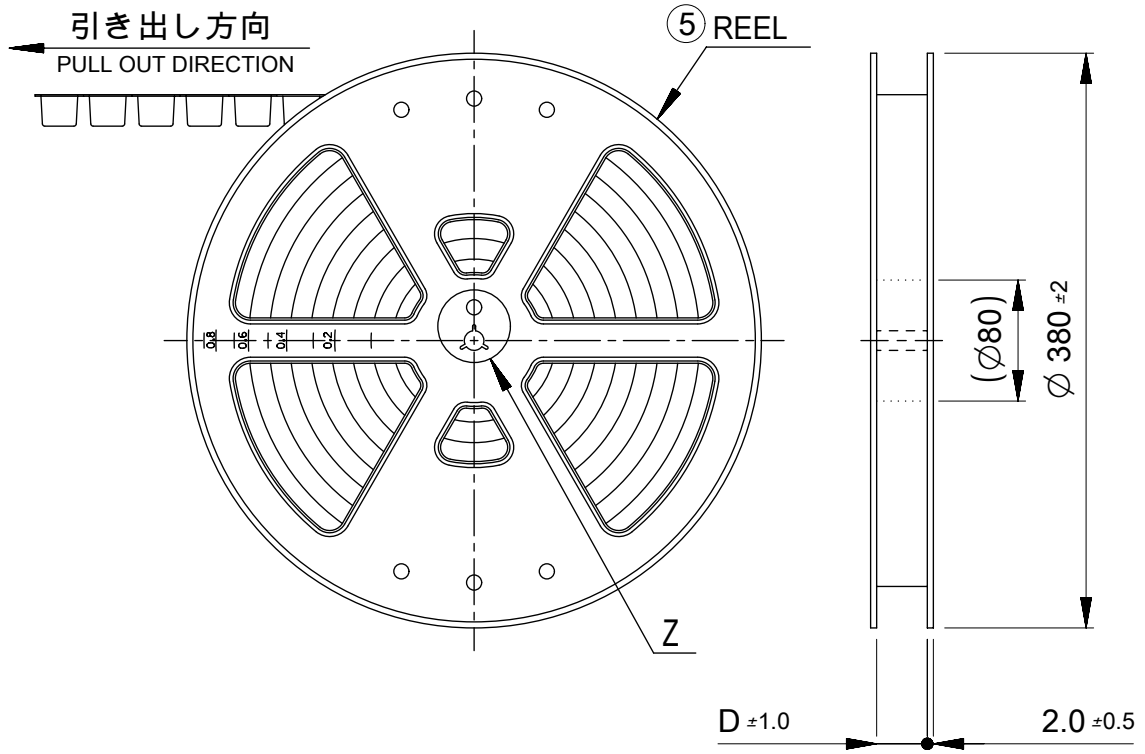


POLARIZED RECOMMENDED PCB LAYOUT(APPLY TO ALL CIRCUIT) : COMPONENT SIDE
(REFERENCE: PCB THICKNESS 1.0mm, STENCIL THICKNESS 0.12mm, APERTURE RATIO 100%)

 :パターン禁止エリア
RESTRICTED AREA
NO PCB COMPONENTS ALLOWED

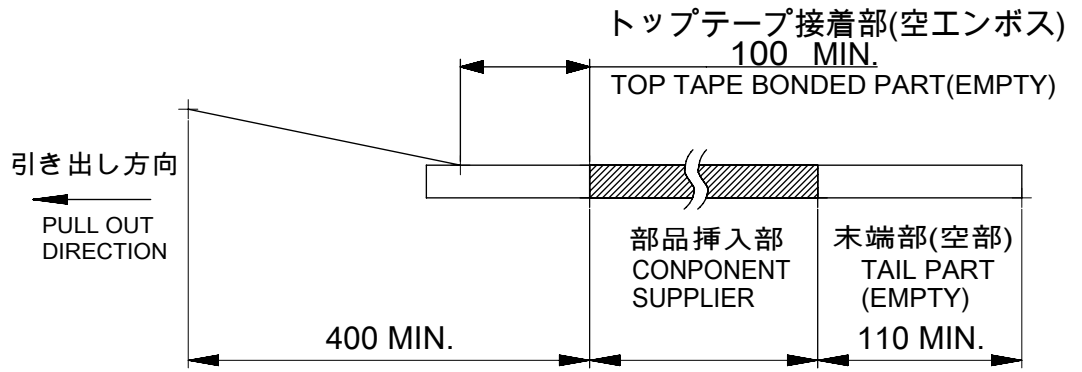


THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION														
DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex							
mm		NTS												
GENERAL TOLERANCES (UNLESS SPECIFIED)				EC NO: 615136 DRWN: AISHIKAWA 2019/09/06 CHK'D: AIDA 2019/09/11 APPR: SAKIYAMA 2019/09/17			PICO-CLASP 1.0 W/B DUAL ROW VT SMT GOLD PLATING 0.76 MICRO-METER							
ANGULAR TOL ± 3.0°														
4 PLACES		± 0.2												
3 PLACES		± 0.2												
2 PLACES		± 0.2		INITIAL REVISION:			PRODUCT CUSTOMER DRAWING							
1 PLACE		± 0.2												
0 PLACES		± 0.2												
DRWN: AISHIKAWA 2019/03/29				APPR: KOMURAKAMI 2019/04/03			DOCUMENT NUMBER		DOC TYPE	DOC PART	REVISION			
APPR: KOMURAKAMI							2035650000-SD		PSD	000	B			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION 		DRAWING A3-SIZE		SERIES 203565		MATERIAL NUMBER SEE SHEET 5		CUSTOMER	SHEET NUMBER 2 OF 4	



NOTES

10. 梱包数量:1100個/リール
NUMBER OF CONNECTORS : 1100 PIECES/REEL
11. リードテープ長さ
LEAD TAPE LENGTH

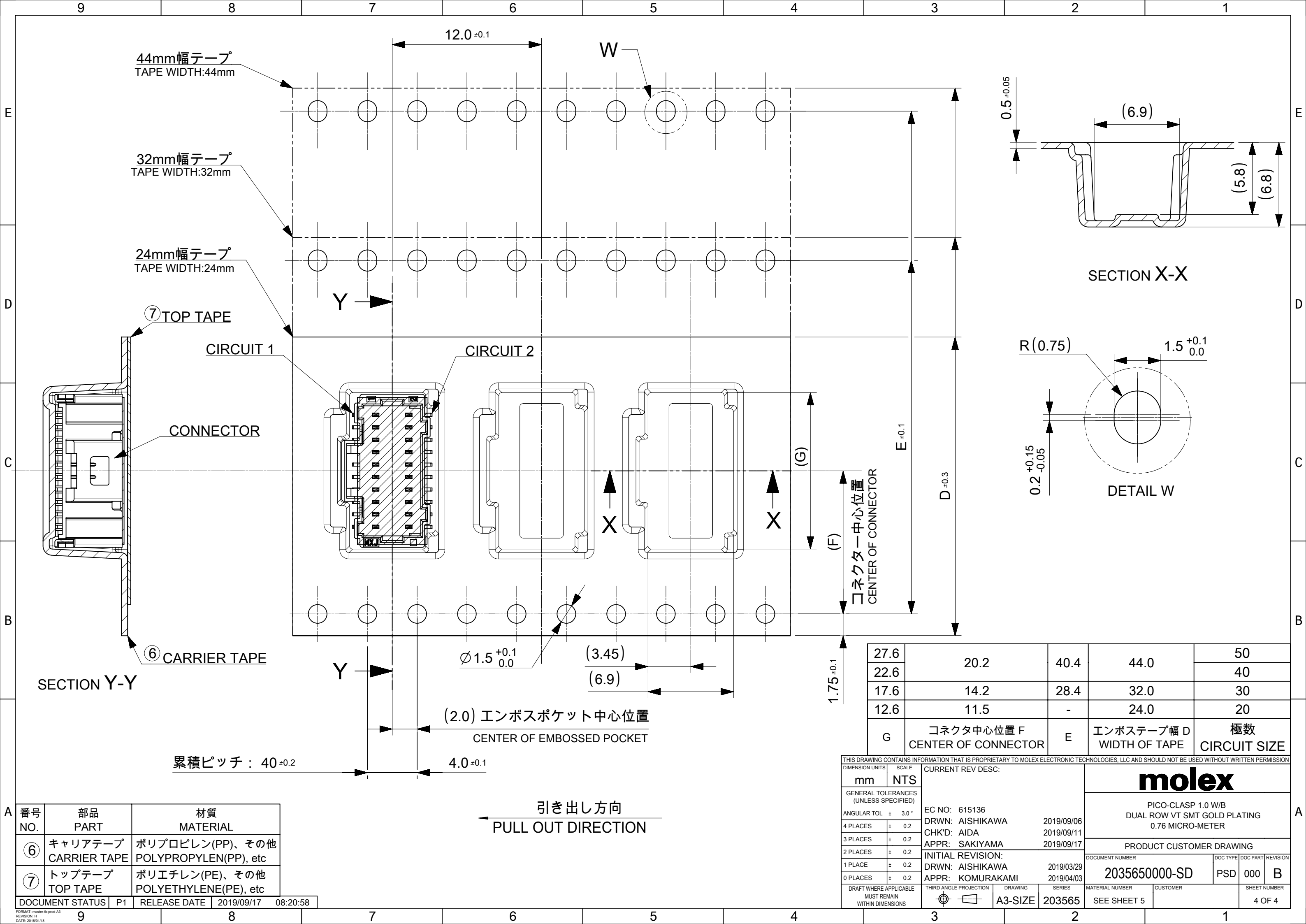


12. トップテープの剥離強度はIEC60286-3に準拠。
TOP TAPE PEELING FORCE IS DEFINED BY IEC60286-3.
13. 梱包仕様書 : 2035659200 PS 200
PACKAGE SPECIFICATION:

45.5	50
	40
33.5	30
25.5	20
D	極数 CIRCUIT SIZE

番号 NO.	部品 PART	材質 MATERIAL
⑤	リール REEL	ポリスチレン(PS) <リサイクル材を含む> POLYSTYRENE(PS) <RECYCLE MATERIAL CONTAINED>
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THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		CURRENT REV DESC:		molex		
DIMENSION UNITS mm		SCALE NTS		PICO-CLASP 1.0 W/B DUAL ROW VT SMT GOLD PLATING 0.76 MICRO-METER		
GENERAL TOLERANCES (UNLESS SPECIFIED)		EC NO: 615136		PRODUCT CUSTOMER DRAWING		
ANGULAR TOL ± 3.0 °		DRWN: AISHIKAWA 2019/09/06		DOCUMENT NUMBER		
4 PLACES ± 0.2		CHK'D: AIDA 2019/09/11		2035650000-SD		
3 PLACES ± 0.2		APPR: SAKIYAMA 2019/09/17		PSD 000 B		
2 PLACES ± 0.2		INITIAL REVISION:		MATERIAL NUMBER		
1 PLACE ± 0.2		DRWN: AISHIKAWA 2019/03/29		CUSTOMER		
0 PLACES ± 0.2		APPR: KOMURAKAMI 2019/04/03		SEE SHEET 5		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION		SHEET NUMBER		
		A3-SIZE 203565		3 OF 4		



44mm幅テープ
TAPE WIDTH:44mm

32mm幅テープ
TAPE WIDTH:32mm

24mm幅テープ
TAPE WIDTH:24mm

⑦ TOP TAPE

CIRCUIT 1

CIRCUIT 2

CONNECTOR

⑥ CARRIER TAPE

SECTION Y-Y

SECTION X-X

DETAIL W

(2.0) エンボスポケット中心位置
CENTER OF EMBOSSED POCKET

累積ピッチ : 40 ±0.2

引き出し方向
PULL OUT DIRECTION

27.6	20.2	40.4	44.0	50
22.6				40
17.6	14.2	28.4	32.0	30
12.6	11.5	-	24.0	20
G	コネクタ中心位置 F CENTER OF CONNECTOR		E	エンボステープ幅 D WIDTH OF TAPE
				極数 CIRCUIT SIZE

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		CURRENT REV DESC:			molex			
DIMENSION UNITS mm		SCALE NTS		GENERAL TOLERANCES (UNLESS SPECIFIED)		PICO-CLASP 1.0 W/B DUAL ROW VT SMT GOLD PLATING 0.76 MICRO-METER		
ANGULAR TOL		± 3.0 °		4 PLACES ± 0.2		PRODUCT CUSTOMER DRAWING		
3 PLACES ± 0.2		2 PLACES ± 0.2		1 PLACE ± 0.2		DOCUMENT NUMBER		
0 PLACES ± 0.2		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION		2035650000-SD		
		DRAWING		SERIES		PSD 000 B		
		A3-SIZE		203565		SHEET NUMBER		
						4 OF 4		

番号 NO.	部品 PART	材質 MATERIAL
⑥	キャリアテープ CARRIER TAPE	ポリプロピレン(PP)、その他 POLYPROPYLEN(PP), etc
⑦	トップテープ TOP TAPE	ポリエチレン(PE)、その他 POLYETHYLENE(PE), etc

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